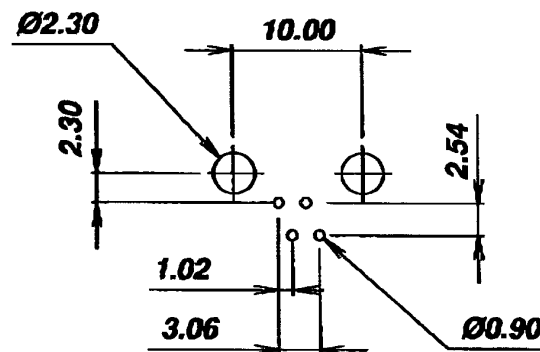
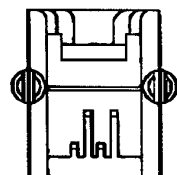
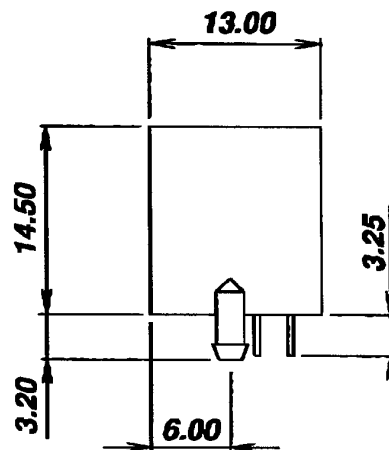
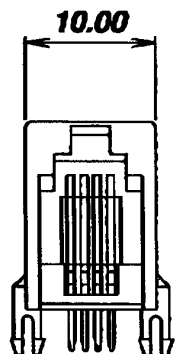




PCB LAYOUT

SPECIFICATION :

1. Electrical Char.

Insulation Resistance : 500M-ohm Min.

Contact Resistance : 20M-ohm Max.

Rating Current : 1.5A Min.

Dielectric Voltage : 1,000 RMS 60 Sec. Min.

2. Physical Char.

Housing : PBT 20% Glass Filled (UL 94V-0)

Color : Black / Medium Gray Color

Spring Wire : 0.46mm Diameter Phosphor Bronze

Gold Plating Over Nickel

Temperature Range : - 25 +90 C

Durability : 500 Mating cycles Min.

HC-026-4-A-X

A=4p4c

Gold
plated

1=15u, 3=50u
2=30u, 4= 6 u



HO CHIENT

NO. 6 LANE 130, SEC 1, KUANG FU ROAD,
SAN CHUNG CITY, TAIPEI SHIEN, TAIWAN
TEL: 886-2-2995-3505, FAX: 886-2-2995-0360

TITLE

RJ11 Mini Low Profile PCB Jack

UL & cUL FILE NO. E131820

MODULAR JACKS ASSY FOR
HC-026-4-A-X

SCALE SIZE DWG. NO. 9611 SERIES

DO NOT SCALE DRAWING	TOLERANCES UNLESS OTHERWISE NOTED	INCH	MM	DR.	DATA
 THIRD ANGLE PROJECTION	LINEAR $\frac{MM}{INCH}$	0.01±0.1	0.01±0.25	Steven	AUG-13 '02
		0.001±0.05	0.001±0.13	CK'D	
		0.0001±0.02	0.0001±0.05	Johnn	AUG-13 '02
MM INCH	ANGLE ±0°30'	RADIAL	+0.45 -0.15	APP'D Billy	AUG-13 '02

DWG. NO.

AS026001